

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|----------|--------------|-----------|------------|------------|
| 878 | FDMA8878 | MicroFET 2x2 | 7 " | 8 mm | 3000 units |

FAIRCHILD

1

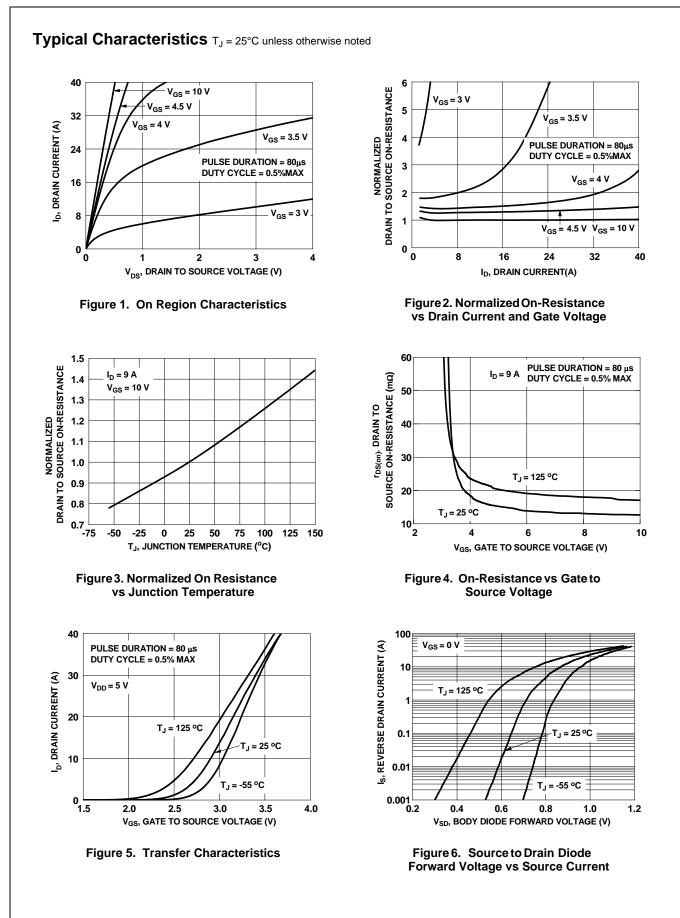
| FDMA8878 Single N-Channel |
|---------------------------|
| Power |
| ň® |
| MOSFET |

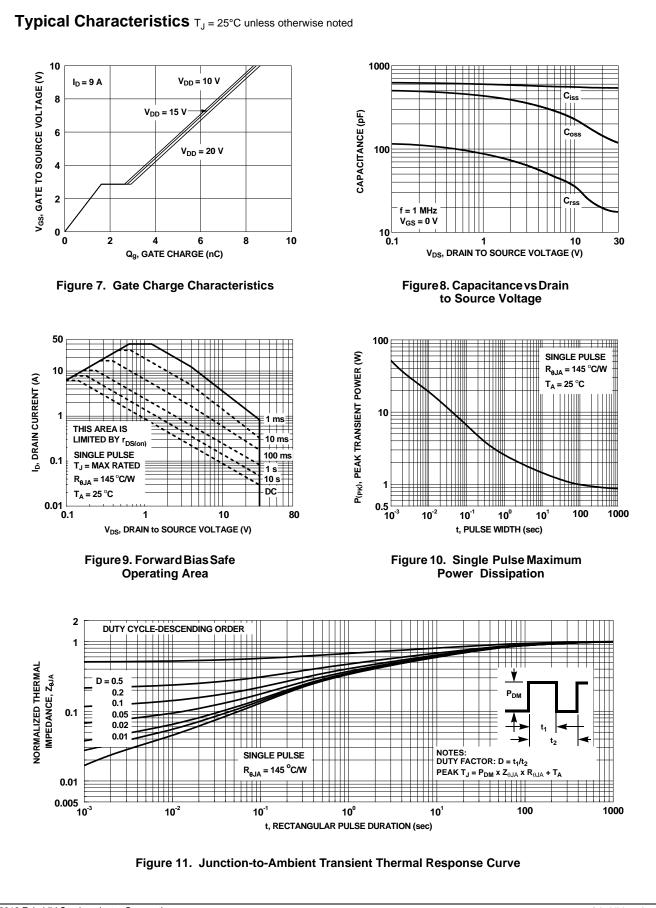
| teristics Drain to Source Breakdown Voltage | | | Тур | Max | |
|---|---|--|--|---|---|
| 0 | | | | | |
| 0 | I _D = 250 μA, V _{GS} = 0 V | 30 | | | V |
| Breakdown Voltage Temperature | | | | | |
| Coefficient | $I_D = 250 \ \mu$ A, referenced to 25 °C | | 26 | | mV/°C |
| Zero Gate Voltage Drain Current | rain Current $V_{DS} = 24 V, V_{GS} = 0 V$ | | | 1 | μA |
| Gate to Source Leakage Current, Forward $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$ | | | | 100 | nA |
| teristics | | | | | |
| | $V_{GS} = V_{DS}$, $I_{D} = 250 \ \mu A$ | 1.2 | 1.8 | 3.0 | V |
| Gate to Source Threshold Voltage | | | _ | | |
| Temperature Coefficient | $I_D = 250 \ \mu A$, referenced to 25 °C | | -5 | | mV/°C |
| | V _{GS} = 10 V, I _D = 9.0 A | | 13 | 16 | |
| Static Drain to Source On Resistance | $V_{GS} = 4.5 \text{ V}, I_D = 8.5 \text{ A}$ | | 16 | 19 | mΩ |
| | V_{GS} = 10 V, I _D = 9.0 A, T _J = 125 °C | | 17 | 21 | |
| Forward Transconductance | V _{DD} = 5 V, I _D = 9.0 A | | 41 | | S |
| haractoristics | | | | | |
| | | | 539 | 720 | pF |
| | $V_{DS} = 15 V, V_{GS} = 0 V,$ | | | - | pF |
| | f = 1 MHz | | | | pF |
| | | | | 00 | Ω |
| Characteristics Turn-On Delay Time | | | 6 | 12 | ns |
| Rise Time | V _{DD} = 15 V, I _D = 9.0 A, | | 2 | 10 | ns |
| Turn-Off Delay Time | V_{GS} = 10 V, R_{GEN} = 6 Ω | | 14 | 25 | ns |
| Fall Time | | | 2 | 10 | ns |
| Total Gate Charge | $V_{GS} = 0 V$ to 10 V | | 8.5 | 12 | nC |
| Total Gate Charge | $V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$ | | 4.1 | 5.8 | nC |
| Total Gate Charge | I _D = 9.0 A | | 1.6 | | nC |
| Gate to Drain "Miller" Charge | | | 1.2 | | nC |
| ce Diode Characteristics | | | | | |
| | $V_{cc} = 0 V I_c = 2 0 A$ (Note 2) | | 0.75 | 12 | |
| Source to Drain Diode Forward Voltage | | | | | V |
| Reverse Recovery Time | | | 16 | 28 | ns |
| Reverse Recovery Charge | I _F = 9.0 A, di/dt = 100 A/μs | | 4 | 10 | nC |
| | teristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance haracteristics Input Capacitance Output Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Drain "Miller" Charge Ce Diode Characteristics Source to Drain Diode Forward Voltage Reverse Recovery Time | teristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$ Gate to Source Threshold Voltage $I_D = 250 \ \mu A$, referenced to 25 °CTemperature Coefficient $V_{GS} = 10 \ V$, $I_D = 9.0 \ A$ Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 9.0 \ A$ Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 9.0 \ A$, $T_J = 125 \ ^{\circ}C$ Forward Transconductance $V_{DD} = 5 \ V$, $I_D = 9.0 \ A$, $T_J = 125 \ ^{\circ}C$ Forward Transconductance $V_{DD} = 5 \ V$, $I_D = 9.0 \ A$ Input Capacitance $V_{DS} = 15 \ V$, $V_{GS} = 0 \ V$, f = 1 MHzCharacteristics $V_{DD} = 15 \ V$, $I_D = 9.0 \ A$, $V_{GS} = 10 \ V$, $R_{GEN} = 6 \ \Omega$ Turn-On Delay Time $V_{GS} = 0 \ V \ to 10 \ V$ $V_{GS} = 0 \ V \ to 4.5 \ V$ $I_D = 9.0 \ A$ Fall Time $V_{GS} = 0 \ V \ to 4.5 \ V$ $I_D = 9.0 \ A$ Total Gate Charge $V_{GS} = 0 \ V \ to 4.5 \ V$ $I_D = 9.0 \ A$ Gate to Drain "Miller" Charge $V_{GS} = 0 \ V, \ I_S = 2.0 \ A$ | teristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu$ A1.2Gate to Source Threshold Voltage $I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 250 \ \mu$ A, referenced to 25 °CStatic Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 9.0 \ A$ $V_{GS} = 10 \ V, \ I_D = 9.0 \ A$ Static Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 9.0 \ A, \ T_J = 125 \ °C$ Forward TransconductanceNumber of the transconductance $V_{DD} = 5 \ V, \ I_D = 9.0 \ A$ $V_{CS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$ Input Capacitance $V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$ $V_{CS} = 10 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ Reverse Transfer CapacitanceV_{DD} = 15 \ V, \ V_{CS} = 0 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ Reverse \ Transfer CapacitanceCharacteristicsTurn-On Delay TimeV_{CS} = 10 \ V, \ R_{CS} = 0 \ V \ to \ 10 \ V \ V_{DD} = 15 \ V \ I_D = 9.0 \ A, \ V_{DD} = 15 \ V \ I_D = 9.0 \ A \ I_D = 9.0 $ | teristicsGate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}$, $I_D = 250 \ \mu$ A1.21.8I_D = 250 \ \muA, referenced to 25 °C-5V_{GS} = 10 V, I_D = 9.0 A13Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 9.0 \ A$ 16V_{GS} = 10 V, I_D = 9.0 \ A, T_J = 125 °C17Forward Transconductance $V_{DD} = 5 \ V$, $I_D = 9.0 \ A$ 41haracteristicsInput Capacitance Reverse Transfer Capacitance $V_{DS} = 15 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz539Output Capacitance Gate Resistance $V_{DS} = 15 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz172Characteristics1.366Rise Time Filme $V_{DD} = 15 \ V$, $I_D = 9.0 \ A$, $V_{GS} = 10 \ V$, $R_{GEN} = 6 \ \Omega$ 14Fall Time Fall Time2144Total Gate Charge Gate Charge $V_{GS} = 0 \ V$ to $10 \ V$ $V_{CS} = 0 \ V$ to $4.5 \ V$ $V_{DD} = 15 \ V$ $I_D = 9.0 \ A$ 1.6Gate to Drain "Miller" Charge $V_{GS} = 0 \ V$, $I_S = 2.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{CS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{CS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{CS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 100 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{CS} = 0 \ V$, $I_S = 9.0 \ A$ $I_S = 9.0 \ A$ 1.6Gate Charge Gate to Drain Diode Forward Voltage $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 100 \ A$ | teristics Gate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu$ A 1.2 1.8 3.0 Gate to Source Threshold Voltage $I_D = 250 \ \mu$ A, referenced to $25 \ ^{\circ}$ C -5 -5 Temperature Coefficient $I_D = 250 \ \mu$ A, referenced to $25 \ ^{\circ}$ C -5 -5 Static Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 9.0 \ A$ 13 16 Forward Transconductance $V_{DD} = 5 \ V, \ I_D = 9.0 \ A$ 11 17 21 haracteristics $V_{DD} = 5 \ V, \ I_D = 9.0 \ A$ 41 1 172 230 number Capacitance $V_{DS} = 15 \ V, \ V_{CS} = 0 \ V,$ $f = 1 \ MHz$ 24 35 Gate Resistance 1.3 16 12 13 16 Characteristics $V_{DD} = 15 \ V, \ V_{CS} = 0 \ V,$ $172 \ 230$ 24 35 Gate Resistance 1.3 1.3 1.3 1.3 1.4 Characteristics $V_{DD} = 15 \ V, \ I_D = 9.0 \ A,$ 2 10 1.4 25 Turn-Off Delay Time $V_{GS} = 0 \ V to 10 \ V$ |

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

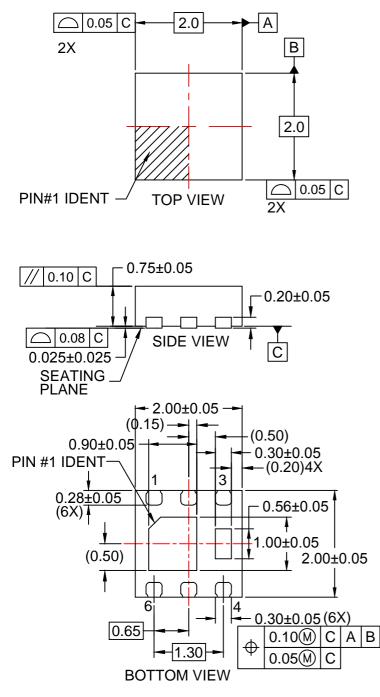
3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

FDMA8878 Single N-Channel Power Trench[®] MOSFET



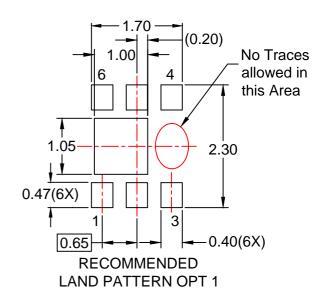


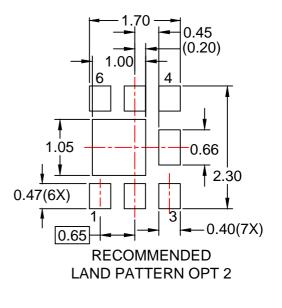
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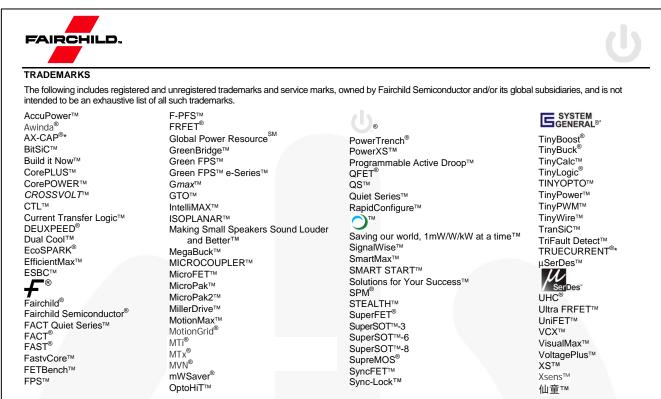
NOTES:

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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
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